

Data Sheet

Customer:	
Part No:	M4.8BRGB9UC1A
Sample No:	
Description:	4.8mm Mushroom Red/Green/Blue LED
Item No:	

Customer					
Check Inspection Approval Date					

Y.LIN						
Drawn	Check Approval Date					
			2014-10-13			

TEL:0769-87181888 FAX:0769-87187333

E-mail:yonglin@y-lin.com Http://www.yong-lin.net

Mainland address: Jinhe the third Industrial Zone, Zhangmutou Town

Dongguan Guangdong China

H.K address:Unit 503 5/F,Silvercord Tower 230 Canton Road Tsimshatsuikl



M4.8BRGB9UC1A

Features:

- . Choice of various viewing angles
- . Available on tape and reel.
- . Reliable and robust
- . Pb free
- .The product itself will remain within RoHS compliant version.

Technical Data Sheet

This product is generally used as indicator and luminary for electronic equipment such as household appliance, communication equipment, and dashboard

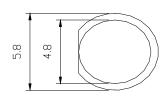


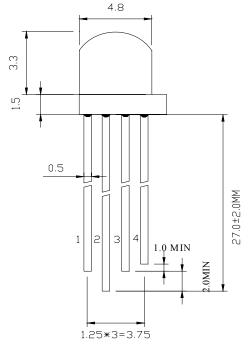
Applications

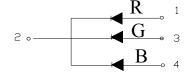
- TV set
- Monitor
- Telephone
- Computer



Package Dimensions:







NOTES

- 1.All dimensions are in millimeters .
- 2.Tolerance is ±0.25mm unless otherwise noted.

REV NO: A/1 Page :1 of 5

M4.8BRGB9UC1A

Selection Guide

Part No.	Dice	Lens Type	Luminous intensity(mcd) @ 20mA			Viewing Angle
1 417 1 100			Min	Тур	Max	201/2
M4.8BRGB9UC1A	(R)AlGaInP	Water Clear	100	150	230	
	(G)InGaN		500	800	1300	110
	(B)InGaN		150	230	350	

Note:

- 1.1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
- 2.the above luminous intensity measurement allowance tolerance $\pm 15\%$

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.(R/G/B)	Typ.(R/G/B)	Max.(R/G/B)	Units	test conditions
Forward Voltage	VF	1.8/2.8/2.8	2.0/3.2/3.2	2.4/3.6/3.6	V	IF=20mA
Reverse Current	IR			10	uA	VR = 5V
Dominate Wavelength	λd	620/515/463		630/525/475	nm	IF=20mA

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Units
Power Dissipation	Pd(R/G/B)	60/90/90	mW
DC Forward Current	IF	25	mA
Peak Forward Current [1]	IFP	60	mA
Reverse Voltage	VR	5	V
Operating Temperature	Topr	-20~+80	°C
Storage Temperature	Tstg	-40~+100	°C
Lead Soldering Temperature [1.6mm(.063") From Body]		260°C for 5 seconds	

Note:

- 1. 1/10 Dut cycle,0.1ms pulse width.
- 2. The above forward voltage measure ment allowance tolerance $\pm 0.1 V$.

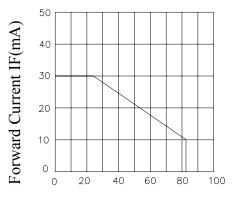
REV NO: A/1 Page :2 of 5



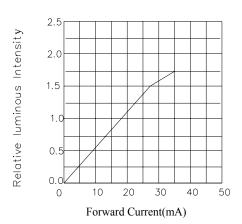
M4.8BRGB9UC1A

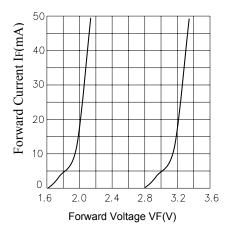
Typical optical characteristics curves

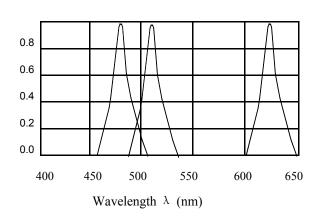
Ambient Temperature VS. Forward Current

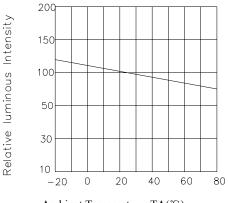


Ambient Temperature (° C)

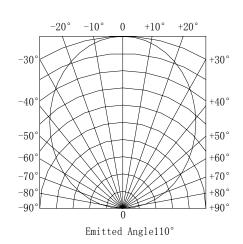








Ambient Temperature $TA(^{\circ}C)$



REV NO: A/1 Page :3 of 5



M4.8BRGB9UC1A

Reliability Test

Classification	Test Item	Test Condition	Reference Standaed
		Ta=Under Room Temperature As	MIL-STD-750D:1026(1995)
	Operation Life	Per Data Sheet Maximum Rating	MIL-STD-883D:1005(1991)
		*Test Time=1000HRS(-24HRS,+72HRS)	JIS C 7021:B-1(1982)
	High Temperature	Ta=65±5°C	
	High Humidity	RH=90~95%	MIL-STD-202F:103(1980) JIS C 7021:B-11(1982)
	Storage	Test Time=240HRS± 2HRS	
Endurance Test	High Temperature	Ta=65±5℃	
	High Humidity	RH=90~95%	JIS C 7021:B-11(1982)
	Reverse BIAS	Test Time=500HRS(-24HRS,+48HRS)	
	High Temperature	Ta=105±5°C	MIL-STD-883D:1008(1991)
	Storage	*Test Time=1000HRS(-24HRS,+72HRS)	JIS C 7021:B-10(1982)
	Low Temperature Storage	Ta=55±5°C *Test Time=1000HRS(-24HRS,+72HRS)	JIS C 7021:B-12(1982)
			MIL-STD-202F:107D(1980)
	Temperature	$105^{\circ}\text{C} \sim 25^{\circ}\text{C} \sim -55^{\circ}\text{C} \sim 25^{\circ}\text{C}$	MIL-STD-750D:1051(1995)
	Cycling	30mins 5mins 30mins 5mins	MIL-STD-883D:1010(1991)
		10Cycles	JIS C 7021:A-4(1982)
	Thermal	105°C±5°C ~-55°C±5°C	MIL-STD-202F:107D(1980)
	Shock	10mins 10mins	MIL-STD-750D:1051(1995)
		10Cycles	MIL-STD-883D:1010(1991)
Environmental Test		T.sol=260±5°C	MIL-STD-202F:210A(1980)
	Solder Resistance	Dwell Time=10±lsecs	MIL-STD-750D:2031(1995)
			JIS C 7021:A-1(1982)
			MIL-STD-202F:208D(1980)
	Solderability	T.sol=230±5°C	MIL-STD-750D:2026(1995)
		Dwell Time=5±lsecs	MIL-STD-883D:2003(1991)
			JIS C 7021:A-2(1982)

The appearance and specifications of the product may be modified for improvement, without prior notic

REV NO: A/1 Page :4 of 5



M4.8BRGB9UC1A

1.Storage

It is recommended that LEDs out of their original packaging are used within three months.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

2. Cleaning

Use alcohol-based cleaning solvent such as isopropyl alcohol to clean the LEDs if necessary.

3. Soldering

When soldering leave a minimum of 2mm clearance from the base of the lens to the soldering point.

Dipping the lens into the solder must be avoided.

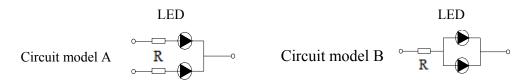
Do not apply any external stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering conditions:

Solderin	ng iron	Wave soldering		
Temperature	320°C Max	Pre-heat Pre-heat time	100°C Max 60 sec.Max	
Soldering time	3 sec.Max (one time only)	Solder wave Soldering time	260°C Max 5 sec.Max	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED.

4.Drive Method

An LED is a current-operated device, In order to ensure intenity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.



- (A)Recommended circuit
- (B)The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

REV NO: A/1 Page :5 of 5